Overview

HP 240 G5 Notebook PC



1. Webcam LED

- 2. Webcam
- 3. Microphone
- 4. Touchpad buttons
- 5. Touchpad
- 6. SD Card slot
- 7. Audio in/out combo jack

- Front/Left
 - 8. USB 2.0 port
 - 9. USB 3.0 port
 - 10. HDMI port
 - 11. Ethernet port
 - 12. VGA port
 - 13. Power jack
 - 14. Power button



Overview



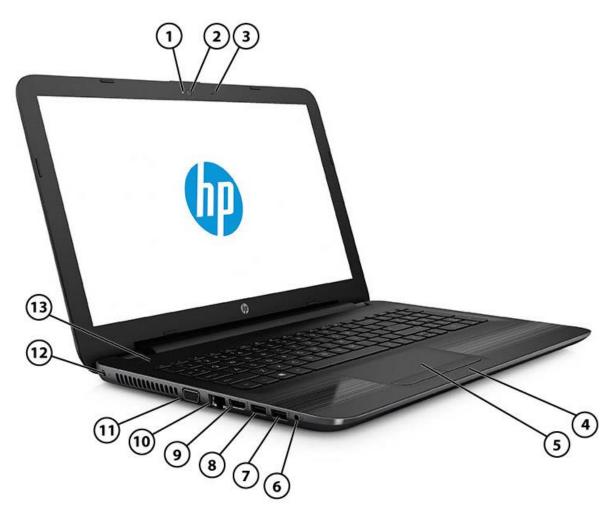
- 1. Power indicator LED
- 2. Hard drive indicator LED
- 3. USB 2.0 port

- Rear/ Right
 - 4. Optical drive (optional)
 - 5. Security lock slot



Overview

HP 250 G5 Notebook PC



- 1. Webcam LED
- 2. Webcam
- 3. Microphone
- 4. Touchpad buttons
- 5. Touchpad
- 6. Audio in/out combo jack
- 7. USB 2.0 port

- Front/Left
 - 8. USB 3.0 port
 - 9. HDMI port
 - 10. Ethernet port
 - 11. VGA port
 - 12. Power jack
 - 13. Power button



Overview



Rear/ Right

- 1. Power indicator LED , Hard drive indicator LED
- 2. SD Card slot
- 3. USB 2.0 port

- 4. Optical drive (optional)
- 5. Security lock slot



Overview

AT A GLANCE

- Window 10 versions, Windows 7 Professional (Available through downgrade rights from Windows 10 Pro 64), or FreeDOS 2.0
- Choice of the latest Intel[®] Core[™], Intel[®] Pentium[®], or Intel[®] Celeron[®] processors
- Intel[®] HD Graphics or AMD Radeon™ R5 (Up to 2 GB of dedicated video memory) (HP 250 G5 only)
- Display choices include:
 - HP 240 G5: 14.0" diagonal HD
 - HP 250 G5: 15.0" diagonal HD or FHD
- Choice of hard drives up to 1 TB, hybrid drives up to 1 TB SSHD with 8 GB NAND (HP 250 G5 only) or solid state drives up to 256 GB (HP 250 G5 only)
- Weight starting at:
 - HP 240 G5: 3.95 lbs (1.79 kg)
 - HP 250 G5: 4.32 lbs (1.96 kg)
 - Security features including FW TPM 2.0 and lock slot (cable not included)
- Keyboard
 - Full size textured island-style keyboard on the HP 240 G5
 - Full size textured island-style keyboard with numeric pad on the HP 250 G5
- Touchpad with gestures support
- HP webcam with single digital microphone and HD or VGA camera
- HD Audio with DTS Studio Sound™ optimized for high fidelity audio
- One USB 3.0 port and two USB 2.0 ports
- Wireless LAN (WLAN) up to 802.11ac to keep you connected

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Features

PRODUCT NAMES

HP 240 G5 Notebook PC

HP 250 G5 Notebook PC

OPERATING SYSTEM

Preinstalled

Windows 10 Pro 64¹ Windows 10 Home 64¹ Windows 7 Professional 64 (Available through downgrade rights from Windows 10 Pro 64)² FreeDOS 2.0

- 1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://http://www.microsoft.com.
- 2. This system is preinstalled with Windows 7 Professional software and also comes with a license and media for Windows 10 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

PROCESSORS

HP 240 G5

Intel[®] Core[™] i5-6200U with Intel[®] HD Graphics 520 (2.3 GHz, up to 2.8 GHz with Intel[®] Turbo Boost Technology, 3 MB cache, 2 cores)¹ Intel[®] Core[™] i3-6100U with Intel[®] HD Graphics 520 (2.3 GHz, 3 MB cache, 2 cores)¹ Intel[®] Core[™] i3-5005U with Intel[®] HD Graphics 5500 (2.0 GHz, 3 MB cache, 2 cores)¹ Intel[®] Celeron[®] N3060 with Intel[®] HD Graphics 400 (1.6 GHz, up to 2.48 GHz with Intel[®] HD Graphics Intel[®] Pentium[®] A1020 with Intel[®] HD Graphics (2.41GHZ, up to 2.66GHz with Intel[®] Turbo Boost Technology) 2MB cache, 4 cores)¹

HP 250 G5

Intel® Core[™] i7-6500U with Intel® HD Graphics 520 (2.5 GHz, up to 3.1 GHz with Intel Turbo Boost Technology, 4 MB cache, 2 cores)¹ Intel® Core[™] i5-6200U with Intel® HD Graphics 520 (2.3 GHz, up to 2.8 GHz with Intel® Turbo Boost Technology, 3 MB cache, 2 cores)¹ Intel® Core[™] i3-5005U with Intel® HD Graphics 5500 (2.0 GHz, 3 MB cache, 2 cores)¹ Intel® Pentium® N3710 with Intel® HD Graphics 405 (1.60 GHz, up to 2.56 GHz with Intel® Turbo Boost Technology, 2 MB cache, 4 cores)¹ Intel® Celeron® N3060 with Intel® HD Graphics 400 (1.6 GHz, up to 2.48 GHz with Intel® Turbo Boost Technology, 2 MB cache, 2 cores)¹



Features

1. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering is not a measurement of higher performance. **NOTE:** Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.

CHIPSET

Integrated with processor

GRAPHICS

HP 240 G5 Integrated Intel® HD Graphics 520¹ Intel® HD Graphics 5500¹ Intel® HD Graphics 400¹ Support HD Decode, DX12, and HDMI

HP 250 G5

Intel[®] HD Graphics 520¹ Intel[®] HD Graphics 5500¹ Intel[®] HD Graphics 405¹ Intel[®] HD Graphics 400¹

Discrete (HP 250 G5 only)

AMD Radeon™ R5 (Up to 2 GB of dedicated video memory)² Support HD Decode, DX12, and HDMI

1. HD content required to view HD images.

2. AMD Dynamic Switchable Graphics technology requires an Intel processor, plus an AMD Radeon[™] discrete graphics configuration and is not available on FreeDOS. With AMD Dynamic Switchable Graphics technology, full enablement of all discrete graphics video and display features may not be supported on all systems (e.g. OpenGL applications will run on the integrated GPU or the APU as the case may be).

DISPLAY

HP 240 G5 Internal 14.0" diagonal WLED HD Anti-glare Slim (1366 x 768), SVA¹

VGA

Port supports resolutions up to 1920 x 1200 external resolution @ 60 Hz

HDMI

Port supports resolutions up to 1920 x 1080 external resolution @ 60 Hz

HP 250 G5 Internal

15.6" diagonal WLED HD Anti-glare Slim (1366 x 768) SVA¹ 15.6" diagonal WLED FHD Anti-glare Slim (1920 x 1080) SVA¹



Features

VGA

Port supports resolutions up to 2560 x 1200 external resolution @ 60 Hz

HDMI

Port supports resolutions up to 1920 x 1080 external resolution @ 60 Hz

1. HD content required to view HD images.

NOTE: Resolutions are dependent upon monitor capability, and resolution and color depth settings.

STORAGE AND DRIVES

Primary Storage Bay

Support all 7mm/9.5mm, SATA 2.5" Hard Drives

HP 240 G5

Hard Drives¹ 500 GB 5400 rpm SATA (7/9.5 mm) 500 GB 7200 rpm SATA (7 mm) 1 TB 5400 rpm SATA (9.5 mm)

HP 250 G5

Hard Drives¹ 500 GB 5400 rpm SATA (7/9.5 mm) 500 GB 7200 rpm SATA (7 mm) 1 TB 5400 rpm SATA (9.5 mm) 1 TB Hybrid

Solid State Drives¹ (HP 250 G5 only) M.2 SATA-3 128 GB SATA-3 256 GB SATA-3 1 TB 5400RPM SSHD w/8GB NAND (9.5mm)

1. For hard drives and solid state drives, GB = 1 billion bytes, TB = 1 trillion bytes. Actual formatted capacity is less. Up to 16 GB (for Windows 7) and up to 30 GB (for Windows 10) of system disk is reserved for the system recovery software.

OPTICAL DRIVES

Fixed 9.5 mm SATA Fixed DVD+/-RW SuperMulti DL¹

1. HD-DVD disks cannot be played on this drive. Note that DVD-RAM cannot read or write to 2.6 GB Single Sided/5.2 GB Double Sided – Version 1.0 media. Actual speeds may vary. Don't copy copyright-protected materials. Double Layer discs can store more data than single layer discs; discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

MEMORY

DDR4 (Intel[®] Core[™] i7-6500U. i5-6200U, i3-6100U processors only) DDR4-2133 (Transfer rates up to 2133 MT/s)



Features

Dual channel support Non customer accessible / upgradeable

Configuration

4096 MB Total System Memory (2048 MB x 2) (HP 250 G5 only) 4096 MB Total System Memory (4096 MB x 1) 6144 MB Total System Memory (2048 MB x 1 + 4096 MB x 1) 8192 MB Total System Memory (4096 MB x 2) 8192 MB Total System Memory (8192 MB x 1) 12288 MB Total System Memory (8192 MB x1 + 4096 MB x 1) 16384 MB Total System Memory (8192 MB x 2)

Maximum

Up to 16 GB

DDR3L(Intel® Core™i3-5005U processor only) DDR3L – 1600 (Transfer rates up to 1600 MT/s) Dual channel support Non customer accessible / upgradeable

Configuration

2048 MB Total System Memory (2048 MB x 1) 4096 MB Total System Memory (2048 MB x 2) (HP 250 G5 only) 4096 MB Total System Memory (4096 MB x 1) 6144 MB Total System Memory (2048 MB x 1 + 4096 MB x 1) 8192 MB Total System Memory (4096 MB x 2) 8192 MB Total System Memory (8192 MB x 1) 12288 MB Total System Memory (8192 MB x 1 + 4096 MB x 1) (HP 250 G5 only) 16384 MB Total System Memory (8192 MB x 2)

Maximum

Up to 16 GB

DDR3L(Intel® Pentium® N3710, Celeron® N3010 only)

DDR3L – 1600 (Transfer rates up to 1600 MT/s)

Single channel support Non customer accessible / upgradeable

Configuration

2048 MB Total System Memory (2048 MB x 1) 4096 MB Total System Memory (4096 MB x 1) 8192 MB Total System Memory (8192 MB x 1) **Maximum** Up to 8 GB



Features

NOTE: Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

NETWORKING/COMMUNICATIONS

Wireless LAN (WLAN)¹

Intel® Dual Band Wireless-AC 3165 802.11 ac (1x1) WiFi + Bluetooth® 4.2 Combo Realtek 802.11b/g/n (1x1) Wi-Fi + Bluetooth® 4.0 Combo Broadcom 802.11 b/g/n (1x1) Wi-Fi + Bluetooth® 4.0 Combo Realtek 802.11b/g/n (1x1) Wi-Fi

Support for Miracast²

Windows 10 Compatible with Miracast-certified devices

1. Wireless access point and Internet service is required and is not included. Availability of public wireless access points limited.

2. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming media players that also support Miracast. You can use Miracast to share what you're doing on your PC and present a slide show. For more information: http://windows.microsoft.com/en-us/windows-8/project-wireless-screen-miracast

Communications¹

Integrated 10/100/1000 Ethernet Integrated 10/100 Ethernet (HP 240 G5 only)

1. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

AUDIO/MULTIMEDIA

Audio

HD Audio with DTS Studio Sound™ (2) Integrated stereo speakers

Camera

HP TrueVision HD¹

- Indicator LED
- USB 2.0
- BSI sensor
- f2.0
- 1280 x 720p by 30 frames per second
- Single digital microphone
- Enable HP Noise Cancellation

1. HD content required to view HD images.

Webcam HP Webcam¹



Features

- Indicator LED
- USB 2.0
- 640 x 480 by 24 frames per second
- Single digital microphone
- Enable HP Noise Cancellation

1. Wireless access point and Internet service is required and is not included. Availability of public wireless access points limited.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

HP 240 G5

Full size textured island-style keyboard without numeric keypad Black

HP 250 G5

Full size textured island-style keyboard with numeric keypad Black

Touchpad

Multitouch gestures enabled Support Modern Trackpad Gestures Taps enabled as default

SOFTWARE AND SECURITY

Preinstalled Software with Windows Operating System **Buy Office** Discover HP Touchpoint Manager¹ Intel[®] Wireless Display² Windows 10 Recovery Manager Installer - CPS Windows 10 Push Button Reset Recovery - CPS **HP Support Assistant HP PC Hardware Diagnostics UEFI HP Communication Recovery Tool** HP ePrint³ HP e-Service HP CoolSense **HP System Event Utility** CyberLink Power Media Player **CyberLink PowerDirector** Adobe® Shockwave® Player

1. HP Touchpoint Manager requires purchase of a subscription and supports Android[™], iOS and Windows 7 or higher operating systems and PCs, notebooks, tablets and smartphones from various manufacturers. Not available in all countries see www.hp.com/touchpoint for availability information.

2. Integrated Intel Wi-Di feature is available on select configurations only and requires separately purchased projector, TV or computer monitor with an integrated or external Wi-Di receiver. External Wi-Di receivers connect to the projector, TV or computer monitor via a standard HDMI cable, also sold separately.



Features

3. Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see www.hp.com/go/eprintcenter). Requires optional broadband module. Broadband use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Separately purchased data plans or usage fees may apply. Print times and connection speeds may vary.

Security

FW TPM 2.0 (UMA only) Security lock slot (Cable not included)

POWER

Power Supply HP 45W Smart AC Adapter HP 65W Smart AC Adapter HP 65W Smart EM Adapter (China and India only) Power cord included is 3.28 feet (1 m) in length

Primary Battery

HP 3-cell 31 WHr (UMA only) HP 4-cell 41Whr

Battery Life 240 G5

	4 cell battery/MM14	3 cell battery/MM14
Intel i5-6200U/ i3-6100U – UMA	9 hours	6 hours 30 minutes
Intel i3-5005U - UMA	9 hours	6 hours 30 minutes
Intel Celeron N3060 – UMA	9 hours	6 hours 30 minutes
250 G5		
	4 cell battery/MM14	3 cell battery/MM14
Intel i7-6500U/ i5-6200U – DSC	8 hours 30 minutes	N/A
Intel i7-6500U/ i5-6200U – UMA	8 hours 15 minutes	6 hours 15 minutes
Intel i3-5005U – DSC	8 hours 15 minutes	N/A
Intel i3-5005U - UMA	8 hours 15 minutes	6 hours
Intel Pentium N3710/ Celeron N3060 – UMA	9 hours 15 minutes	7 hours

System Standby Time TBD

WEIGHTS & DIMENSIONS



HP 240 G5 Notebook PC HP 250 G5 Notebook PC

Features

HP 240 G5 Weight Starting at 3.95 lbs (1.79 kg)¹ (3-cell battery, Solid State Drive)

Dimensions (w x d x h) 13.60 x 9.50 x .94 in 34.54 x 24.15 x 2.39 cm

HP 250 G5 Weight Starting at 4.32 lbs (1.96 kg)¹ (3-cell battery, Solid State Drive)

Dimensions (w x d x h) 15.13 x 10.02 x .96 in 38.43 x 25.46 x 2.43 cm

1. Weight varies by configuration and components.

PORTS/SLOTS

Ports

USB 2.0 ports – Two (One left and one right) USB 3.0 port – One (Left) VGA port – One HDMI v1.4b – One Headphone / microphone combo jack – One RJ-45 / Ethernet - One AC Smart adapter port – One

HP Multi-Format Digital Media Card Reader

Supports SD, SDHC, SDXC

SERVICE AND SUPPORT

HP Services offers 3-yearand 1-year limited warranty options and 90 days software support depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. On-site service and extended coverage is also available. HP Care Pack Services^{1,2} are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc

1. Sold separately or as an optional feature.

2. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. Consult the HP Customer Support Center for details. http://h20000.www2.hp.com/bizsupport/TechSupport/ProductRoot.jsp



DISPLAYS*

14.0" diagonal WLED HD Anti-glare Slim (1366 x	Outline Dimensions (W x H x D)	320.9x205.6x3.0	
768), SVA	Active Area	309.4 x 173.95	
	Weight	290g	
	Diagonal Size	14.0"	
	Surface Treatment	AG	
	Contrast Ratio	300:1	
	Refresh Rate	60Hz	
	Brightness	220 nit	
	Pixel Resolution	Format	1366 x 768
	PIXEL RESOLUTION	Configuration	
	Interface	eDP 1.2	
	LCD Mode	TN	
	PPI	112	
	Viewing Angle	40/40/15/30	
15.6" diagonal WLED HD Anti-glare Slim (1366 x	Outline Dimensions (W x H x D)	360.0 x 224.3 x 3.2mm	
	. ,	211 2 1 1 2 5	
768) SVA	Active Area	344.2 x 193.5	
	Active Area Weight	370g	
	Active Area Weight Diagonal Size	370g 15.6"	
	Active Area Weight Diagonal Size Surface Treatment	370g 15.6" AG	
	Active Area Weight Diagonal Size Surface Treatment Contrast Ratio	370g 15.6" AG 300:1	
	Active Area Weight Diagonal Size Surface Treatment Contrast Ratio Refresh Rate	370g 15.6" AG 300:1 60Hz	
	Active Area Weight Diagonal Size Surface Treatment Contrast Ratio Refresh Rate Brightness	370g 15.6" AG 300:1 60Hz 220 nit Format	Pixel Resolution
	Active Area Weight Diagonal Size Surface Treatment Contrast Ratio Refresh Rate Brightness Pixel Resolution	370g 15.6" AG 300:1 60Hz 220 nit Format Configuration	Pixel Resolution
	Active Area Weight Diagonal Size Surface Treatment Contrast Ratio Refresh Rate Brightness Pixel Resolution Interface	370g 15.6" AG 300:1 60Hz 220 nit Format Configuration eDP 1.2	Pixel Resolution
	Active Area Weight Diagonal Size Surface Treatment Contrast Ratio Refresh Rate Brightness Pixel Resolution	370g 15.6" AG 300:1 60Hz 220 nit Format Configuration	Pixel Resolution
	Active Area Weight Diagonal Size Surface Treatment Contrast Ratio Refresh Rate Brightness Pixel Resolution Interface	370g 15.6" AG 300:1 60Hz 220 nit Format Configuration eDP 1.2 TN 101	Pixel Resolution
	Active Area Weight Diagonal Size Surface Treatment Contrast Ratio Refresh Rate Brightness Pixel Resolution Interface LCD Mode	370g 15.6" AG 300:1 60Hz 220 nit Format Configuration eDP 1.2 TN	Pixel Resolution

15.6" diagonal WLED FHD Outline Dimensions Anti-glare Slim (1920 x (W × H × D)

360.0 x 224.3 x 3.2mm



1080) SVA

Technical Specifications

Active Area	344.16 x 193.59	
Weight	370g	
Diagonal Size	15.6"	
Surface Treatment	AG	
Contrast Ratio	300:1	
Refresh Rate	60Hz	
Brightness	220 nit	
Pixel Resolution	Format	Pixel Resolution
FIXEL RESULUTION	Configuration	
Interface	eDP 1.2	
Outline Dimensions (W x H x D)	360.0 x 224.3 x 3.2mm	
Active Area	344.16 x 193.59	
Weight	370g	
	370g	

* All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

STORAGE AND DRIVES

500 GB 5400 rpm SATA Hard Drive	Drive Weight	95g	
	Capacity	500GB	
	Height	7mm	
	Width	69.65mm	
	Interface	ATA-8, SATA 3.0	
	Transfer Rate	Synchronous (maximum)	600MB/s
	Seek Time (typical reads, including settling)	Single Track	2ms
		Average	12ms
		Maximum	22ms
	Rotational Speed	5400rpm	
	Logical Blocks	976,773,168	
	Operating Temperature	32° to 140° F (0° to 60° C) [top cover temp]
	Features	S.M.A.R.T., NCQ, Ultra DMA	

500 GB 7200 rpm SATA	Drive Weight	95g
Hard Drive	Capacity	500GB
	Height	7mm



	Width	69.85mm	
	Interface	ATA-8, SATA 3.0	
	Transfer Rate	Synchronous (maximum)	600MB/s
	Seek Time	Single Track	2ms
	(typical reads, including	Average	12ms
	settling)	Maximum	22ms
	Rotational Speed	7200rpm	
	Logical Blocks	976,773, 168	
	Operating Temperature	32° to 140° F (0° to 60° C) [top cover temp]
	Features	S.M.A.R.T., NCQ, Ultra DMA	
1 TB 5400 rpm SATA	Drive Weight	115g	
Hard Drive	Capacity	1TB	
	Height	9.5mm	
	Width	69.85mm	
	Interface	ATA-8, SATA 3.0	
	Transfer Rate	Synchronous (maximum)	600MB/s
	Seek Time	Single Track	2ms
	(typical reads, including settling)	Average	12ms
		Maximum	22ms
	Rotational Speed	5400rpm	
	Logical Blocks	1,953,525,168	
	Operating Temperature	32° to 140° F (0° to 60° C) [top cover temp]
	Features	S.M.A.R.T., NCQ, Ultra DMA	

NETWORKING/COMMUNICATIONS**

Intel® Dual Band Wireless-AC 3165 802.11 ac (1x1) WiFi + Bluetooth® 4.2 Combo

Wireless LAN Standards	IEEE 802.11a
	IEEE 802.11b
	IEEE 802.11g
	IEEE 802.11n
	IEEE 802.11ac
Interoperability	Wi-Fi certified
Frequency Band	802.11b/g/n
	• 2.402 – 2.482 GHz
	Note:
	The FCC has declared as of January 1, 2015 products that utilize passive scanning on channel



Technical Specifications

· · · · · · · · · · · · · · · · · · ·	12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
	802.11a/n
	• 4.9 – 4.95 GHz (Japan)
	• 5.15 – 5.25 GHz
	• 5.25 – 5.35 GHz
	• 5.47 – 5.725 GHz
	• 5.825 – 5.850 GHz
	Note:
	Indonesia only supports 5.725 - 5.825 GHz (CH149 - CH161)
Data Rates	• 802.11b: 1, 2, 5.5, 11 Mbps
	• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
	 802.11ac : MCS0 ~ MCS7, (1SS) (20MHz, 40MHz, and 80MHz)
Modulation	Direct Sequence Spread Spectrum
	BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM
Security ¹	 IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only
	AES-CCMP: 128 bit in hardware
	802.1x authentication
	 WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
	WPA2 certification
	• IEEE 802.11i
	 Cisco Certified Extensions, all versions through CCX4 and CCX Lite
	WAPI
Network Architecture	Ad-hoc (Peer to Peer)
Models	Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power ²	• 802.11b : +16dBm minimum
-	• 802.11g : +14dBm minimum
	• 802.11a : +14dBm minimum
	 802.11n HT20(2.4GHz) : +14dBm minimum
	 802.11n HT40(2.4GHz) : +12dBm minimum
	• 802.11n HT40(5GHz) : +12dBm minimum
.	802.11ac 80MHz(5GHz): +11dBm minimum
Power Consumption	Transmit: 2.0 W (max)
	Receive: 1.6 W (max)
	Idle mode (PSP): 180 mW (WLAN Associated)
	Idle mode: 50 mW (WLAN unassociated)
	Connect Standby: 10 mW (WLAN+BT)
	Radio disabled: 5 mW
Power Management	ACPI and PCI Express compliant power management
	Not all configuration components are available in all regions/countries.

Technical Specifications

	802.11 compliant pov	ver saving mode	
Receiver Sensitivity ³	802.11b, 1Mbps : -94	dBm maximum	
	802.11b, 11Mbps : -86dBm maximum		
	802.11g, 6Mbps : -88	dBm maximum	
	802.11g, 54Mbps : -7	4dBm maximum	
	802.11a, 6Mbps : -88	dBm maximum	
	802.11a, 54Mbps : -7	4dBm maximum	
	802.11n, MCS07 : -69	dBm maximum	
	802.11n, MCS15 : -66	dBm maximum	
	802.11ac, 1SS, MCS-0) : -86dBm maximum	
	802.11ac, 1SS, MCS-9) : -61dBm maximum	
	802.11ac, 2SS, MCS-0) : -83dBm maximum	
	802.11ac, 2SS, MCS-9) : -58dBm maximum	
Antenna type	High efficiency anten	na with spatial diversity, mounted in the display enclosure	
	Two embedded dual t	oand 2.4/5 GHz antennas are provided to the card to support WLAN MIMO	
	communications and	Bluetooth communications	
Form Factor	PCI-Express M.2 Mini(Card	
Dimensions	Туре 2230 : 2.3 x 22.0) x 30.0 mm	
	Or		
	Туре 1630 : 2.3 x 16.0) x 30.0 mm	
Weight	Type 2230 : 2.8g		
	Or		
	Type 1630 : 2g		
Operating Voltage	3.3v +/- 9%		
Temperature	Operating	14° to 158° F (–10° to 70° C)	
	Non-operating	–40° to 176° F (–40° to 80° C)	
Humidity	Operating	10% to 90% (non-condensing)	
	Non-operating	5% to 95% (non-condensing)	
Altitude	Operating	0 to 10,000 ft (3,048 m)	
	Non-operating	0 to 50,000 ft (15,240 m)	
LED Activity		FF; LED White – Radio ON	
1. Check latest soft	ware/driver release for r	updates on supported security features.	

1. Check latest software/driver release for updates on supported security features.

2. Maximum output power may vary by country according to local regulations.

3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

Bluetooth Specification	4.0/4.1/4.2 Compliant
Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps
	BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels



Technical Specifications

Transmit Power		• •	erate as a Class II Blue f + 4 dBm for BR and E	
Receiver Sensitivity	Modulation	0.01% BER	0.001% BER	
Legacy	GFSK	-80 dBm	-70 dBm	
	π/4-DQPSK	-80 dBm	-70 dBm	
	8DPSK	-80 dBm	-70 dBm	
Power Consumption	Peak (Tx) 330 mW			
	Peak (Rx) 230 m			
	Selective Suspe			
Range	Legacy Up to 33			
	BLE Up to 99 ft (30 m)		
Electrical Interface	USB 2.0 complia	nt		
Bluetooth Software Supported	Microsoft Windo	ws Bluetooth Soft	ware	
Link Topology				
Electrical Interface	Point to Point, M	Iultipoint Pico Nets	up to 7 slaves	
Bluetooth Software Supported		Bluetooth Security	•	
Security				
Power Management	Microsoft Windows ACPI, and USB Bus Support			
Certifications	Self-configurable to optimize power conservation in all operating			
	-	g Standby, Hold, Pa		operating
Security				ios inclu
Certifications	All necessary regulatory approvals for supported countries, including FCC (47 CFR) Part 15C, Section 15.247 & 15.249			
	FUU (47 UFK) Pai	t 15C, Section 15.2	47 & 15.249	
Bluetooth Profiles Supported	FTC 200 220 FT			
Power Management	ETS 300 328, ETS 300 826			
Certifications	Low Voltage Dir			
	UL, CSA, and CE	Mark		
	Serial Port Profi	le (SPP)1		
	Service Discover	y Application Profi	le (SDAP)	
	Dial-Up Network	king (DUN) ^{1,2}		
	Generic Object E	xchange Profile (G	DEP) ^{1,2}	
Certifications	Object Push Pro	file (OPP) ^{1,2}		
Bluetooth Profiles Supported		Replacement (HCF		
Blueloolii Ploines Supported	Personal Area Networking Profile (PAN) ^{1,2}			
	Human Interface	e Device Profile (HI) ^{1,2}	
	Hands Free Prof	ile (HFP)		
	Advanced Audio	Distribution Profile	e (A2DP)	
	Audio Video Ren	note Control Profile	(AVRCP)	

Bluetooth V4.1/V4.2 support feature

V4.1: ESR5/6/7 compliant



V4.2: ESR8 compliant, LE Secure Connection – Basic.

Wireless LAN Standards	Ni-Fi + Bluetooth [®] 4.0 Combo
wireless LAN Stanuarus	IEEE 802.11b
	IEEE 802.11g IEEE 802.11n
	IEEE 802.1111
Interoperability	Wi-Fi certified
Frequency Band	802.11b/g/n
	• 2.402 – 2.482 GHz
	Note: The FCC has declared as of September 1, 2014 products that utilize
	passive scanning on channel 12/13 and are capable of transmitting must
	fully comply with requirements of 15.247 or otherwise disable those channels.
Data Rates	802.11b: 1, 2, 5.5, 11 Mbps
	802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	802.11n: MCS 0 ~ MCS 07, (20MHz)
Modulation	Direct Sequence Spread Spectrum
	BPSK, QPSK, CCK, 16-QAM, 64-QAM,
Security ¹	 IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g
	mode only
	AES-CCMP: 128 bit in hardware
	802.1x authentication
	• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
	WPA2 certification
	• IEEE 802.11i
	Cisco Certified Extensions, all versions through CCX4 and CCX Lite
	• WAPI
Network Architecture	Ad-hoc (Peer to Peer)
Models	Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power ²	• 802.11b : +16dBm minimum
	• 802.11g : +14dBm minimum
	• 802.11n HT20(2.4GHz) : +13dBm minimum
	• 802.11n HT40(2.4GHz) : +13dBm minimum
	• 802.11n HT20(5GHz) : +12dBm minimum
	• 802.11n HT40(5GHz) : +12dBm minimum
Power Consumption	Transmit: 2.0 W (max)
	Receive: 1.6 W (max) Idle mode (PSP): 180 mW (WLAN Associated)
	Idle mode: 60 mW (WLAN unassociated)
	Radio disabled: 30 mW
Power Management	ACPI and PCI Express compliant power management
י שאבו המוומצכוווכוונ	802.11 compliant power saving mode
	Not all configuration components are available in all regions/countries.
	c04934827– DA 15512 – World Wide – Version 5 – July 25, 2016

Technical Specifications

Receiver Sensitivity ³	802.11b, 1Mbps : -94dBm maximum 802.11b, 11Mbps : -86dBm maximun 802.11g, 6Mbps : -88dBm maximum 802.11g, 54Mbps : -74dBm maximun 802.11n, MCS07 : -69dBm maximum 802.11n, MCS15 : -66dBm maximum	ກ ່ ກ
Antenna type	High efficiency antenna with spatial enclosure Two embedded antennas for 2.4GHz WLAN and Bluetooth communicatior (Support Dual antenna or Single anter requirement)	are provided to the card to support is.
Form Factor	PCI-Express M.2 MiniCard	
Dimensions Weight	Type 2230 : 2.3 x 22.0 x 30.0 mm Or Type 1630 : 2.3 x 16.0 x 30.0 mm Type 2230 : 2.8g	
	Or Type 1630 : 2g	
Operating Voltage	3.3v +/- 9%	
Temperature	Operating Non-operating	14° to 158° F (–10° to 70° C) –40° to 176° F (–40° to 80° C)
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
LED Activity	LED Amber – Radio OFF; LED White – I	• • • •

4. Check latest software/driver release for updates on supported security features.

5. Maximum output power may vary by country according to local regulations.

6. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluet	ooth 4.0/4.1 Wireless Technology
Bluetooth Specification	4.0/4.1 Compliant
Frequency Band	2402 to 2480 MHz
Number of Available Channels	Legacy : 0~79 (1 MHz/CH) BLE : 0~39 (2 MHz/CH)
Data Rates and Throughput	Legacy : 3 Mbps data rate; throughput up to 2.17 Mbps BLE : 1 Mbps data rate; throughput up to 0.2 Mbps Legacy : Synchronous Connection Oriented links up to 3, 64 kbps, voice channels
	Legacy : Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)



Technical Specifications

The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.

Receiver Sensitivity	Modulation	0.01% BER	0.001% BER
Legacy	GFSK	-80 dBm	-70 dBm
	π/4-DQPSK	-80 dBm	-70 dBm
	8DPSK	-80 dBm	-70 dBm
Power Consumption	Peak (Tx) 330 m		
	Peak (Rx) 230 m		
	Selective Susper	nd 17 mW	
Range	Legacy Up to 33	ft (10 m)	
	BLE Up to 99 ft (30 m)	
Electrical Interface	USB 2.0 compliant		
Bluetooth Software Supported	Microsoft Windows Bluetooth Software		
Link Topology			
Electrical Interface	Point to Point. M	ultipoint Pico Nets	up to 7 slaves
Bluetooth Software Supported		luetooth Security I	•
Security			
Power Management	Microsoft Windo	ws ACPI, and USB E	Bus Support
Certifications			••
	Self-configurable to optimize power conservation in all operat		
Security	modes, including Standby, Hold, Park, and Sniff		
-	All necessary regulatory approvals for supported countries, including FCC (47 CFR) Part 15C, Section 15.247 & 15.249		
Certifications	FCC (47 CFR) Par	t 15C, Section 15.2	47 & 15.249
Bluetooth Profiles Supported			
Power Management	ETS 300 328, ET	S 300 826	
Certifications	Low Voltage Directive IEC950		
	UL, CSA, and CE I	Mark	
	Serial Port Profil	e (SPP)1	
	Service Discover	y Application Profi	le (SDAP)
	Dial-Up Networking (DUN) ^{1,2}		
	Generic Object Exchange Profile (GOEP) ^{1,2}		
	Object Push Profile (OPP) ^{1,2}		
Certifications	Hard Copy Cable Replacement (HCRP) ^{1,2}		
Bluetooth Profiles Supported	Personal Area Networking Profile (PAN) ^{1,2}		
	Human Interface Device Profile (HID) ^{1,2}		
	Hands Free Profile (HFP)		
	Advanced Audio Distribution Profile (A2DP)		
	Audio Video Rem		

Bluetooth V4.1 support feature

Slave Connectionless Broadcast



Wireless LAN Standards	IEEE 802.11b
	IEEE 802.11g
	IEEE 802.11n
Interoperability	Wi-Fi certified
Frequency Band	802.11b/g/n
	• 2.402 – 2.482 GHz Note: The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
Data Rates	802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 07, (20MHz)
Modulation	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM,
Security ¹	 IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification IEEE 802.11i Cisco Certified Extensions, all versions through CCX4 and CCX Lite WAPI
Network Architecture	Ad-hoc (Peer to Peer)
Models	Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power ²	• 802.11b : +16dBm minimum
	• 802.11g : +14dBm minimum
	• 802.11n HT20(2.4GHz) : +13dBm minimum
	• 802.11n HT40(2.4GHz) : +13dBm minimum
	• 802.11n HT20(5GHz) : +12dBm minimum

Technical Specifications

·	• 802.11n HT40(5GHz) : +12dBm minimum
Power Consumption	Transmit: 2.0 W (max) Receive: 1.6 W (max) Idle mode (PSP): 180 mW (WLAN Associated) Idle mode: 60 mW (WLAN unassociated)
	Radio disabled: 30 mW
Power Management	ACPI and PCI Express compliant power management 802.11 compliant power saving mode
Receiver Sensitivity ³	802.11b, 1Mbps : -94dBm maximum
	802.11b, 11Mbps : -86dBm maximum
	802.11g, 6Mbps : -88dBm maximum
	802.11g, 54Mbps : -74dBm maximum
	802.11n, MCS07 : -69dBm maximum
	802.11n, MCS15 : -66dBm maximum
Antenna type	High efficiency antenna with spatial diversity, mounted in the display enclosure
Antenna type	
Antenna type Form Factor	enclosure Two embedded antennas for 2.4GHz are provided to the card to support WLAN and Bluetooth communications. (Support Dual antenna or Single antenna, depend on platform
	enclosure Two embedded antennas for 2.4GHz are provided to the card to support WLAN and Bluetooth communications. (Support Dual antenna or Single antenna, depend on platform requirement)
Form Factor	enclosure Two embedded antennas for 2.4GHz are provided to the card to support WLAN and Bluetooth communications. (Support Dual antenna or Single antenna, depend on platform requirement) PCI-Express M.2 MiniCard
Form Factor	enclosure Two embedded antennas for 2.4GHz are provided to the card to support WLAN and Bluetooth communications. (Support Dual antenna or Single antenna, depend on platform requirement) PCI-Express M.2 MiniCard Type 2230 : 2.3 × 22.0 × 30.0 mm Or
Form Factor Dimensions	enclosure Two embedded antennas for 2.4GHz are provided to the card to support WLAN and Bluetooth communications. (Support Dual antenna or Single antenna, depend on platform requirement) PCI-Express M.2 MiniCard Type 2230 : 2.3 x 22.0 x 30.0 mm Or Type 1630 : 2.3 x 16.0 x 30.0 mm
Form Factor Dimensions	enclosure Two embedded antennas for 2.4GHz are provided to the card to support WLAN and Bluetooth communications. (Support Dual antenna or Single antenna, depend on platform requirement) PCI-Express M.2 MiniCard Type 2230 : 2.3 × 22.0 × 30.0 mm Or Type 1630 : 2.3 × 16.0 × 30.0 mm Type 2230 : 2.8g
Form Factor Dimensions	enclosure Two embedded antennas for 2.4GHz are provided to the card to support WLAN and Bluetooth communications. (Support Dual antenna or Single antenna, depend on platform requirement) PCI-Express M.2 MiniCard Type 2230 : 2.3 × 22.0 × 30.0 mm Or Type 1630 : 2.3 × 16.0 × 30.0 mm Type 2230 : 2.8g Or
Form Factor Dimensions Weight	enclosure Two embedded antennas for 2.4GHz are provided to the card to support WLAN and Bluetooth communications. (Support Dual antenna or Single antenna, depend on platform requirement) PCI-Express M.2 MiniCard Type 2230 : 2.3 x 22.0 x 30.0 mm Or Type 1630 : 2.3 x 16.0 x 30.0 mm Type 2230 : 2.8g Or



	Non-operating	–40° to 176° F (–40° to 80° C)
Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
Altitude	Operating Non-operating	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)
I ED Activity	LED Amber Dadie OFFILED White	Dadia ON

LED Activity LED Amber – Radio OFF; LED White – Radio ON

- 7. Check latest software/driver release for updates on supported security features.
- 8. Maximum output power may vary by country according to local regulations.
- 9. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0+EDR Wireless Technology				
Bluetooth Specification	4.0+EDR Compliant			
Frequency Band	2402 to 2480 MHz			
Number of Available Channels	79 (1 MHz) available channels			
Data Rates and Throughput	3 Mbps data rate; throughput up to 2.17 Mbps			
	Synchronous Con	nection Oriented	links up to 3, 64 kbps	, voice channels
	•	nnection Less link 306.9 kbps symme	s 2178.1 kbps/177.1 etric	kbps
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of +4 dBm for BR and EDR.			
Receiver Sensitivity	Modulation	0.01% BER	0.001% BER	
	GFSK	-80 dBm	-70 dBm	
	π/4-DQPSK	-80 dBm	-70 dBm	
	8DPSK	-80 dBm	-70 dBm	
Power Consumption	Peak (Tx) 330 mV			
	Peak (Rx) 230 mV			
	Selective Suspen			
Range	Up to 33 ft (10 m))		



Technical Specifications

Electrical Interface	USB 2.0 compliant	
Bluetooth Software Supported	Microsoft Windows Bluetooth Software	
Link Topology		
Electrical Interface	Point to Point, Multipoint Pico Nets up to 7 slaves	
Bluetooth Software Supported	Full support of Bluetooth Security Provisions	
Security		
Power Management	Microsoft Windows ACPI, and USB Bus Support	
Power Management	Self-configurable to optimize power conservation in all operating	
Certifications	modes, including Standby, Hold, Park, and Sniff	
Security	All necessary regulatory approvals for supported countries, including:	
Certifications	FCC (47 CFR) Part 15C, Section 15.247 & 15.249	
Bluetooth Profiles Supported		
Power Management	ETS 300 328, ETS 300 826	
Power Management Certifications	ETS 300 328, ETS 300 826 Low Voltage Directive IEC950	
-		
-	Low Voltage Directive IEC950 UL, CSA, and CE Mark	
-	Low Voltage Directive IEC950 UL, CSA, and CE Mark Serial Port Profile (SPP) ¹	
-	Low Voltage Directive IEC950 UL, CSA, and CE Mark	
-	Low Voltage Directive IEC950 UL, CSA, and CE Mark Serial Port Profile (SPP) ¹ Service Discovery Application Profile (SDAP)	
Certifications	Low Voltage Directive IEC950 UL, CSA, and CE Mark Serial Port Profile (SPP) ¹ Service Discovery Application Profile (SDAP) Dial-Up Networking (DUN) ^{1,2}	
-	Low Voltage Directive IEC950 UL, CSA, and CE Mark Serial Port Profile (SPP) ¹ Service Discovery Application Profile (SDAP) Dial-Up Networking (DUN) ^{1,2} Generic Object Exchange Profile (GOEP) ^{1,2} Object Push Profile (OPP) ^{1,2} File Transfer Profile (FTP)	
Certifications	Low Voltage Directive IEC950 UL, CSA, and CE Mark Serial Port Profile (SPP) ¹ Service Discovery Application Profile (SDAP) Dial-Up Networking (DUN) ^{1,2} Generic Object Exchange Profile (GOEP) ^{1,2} Object Push Profile (OPP) ^{1,2} File Transfer Profile (FTP) Synchronization Profile (SYNC)	
Certifications	Low Voltage Directive IEC950 UL, CSA, and CE Mark Serial Port Profile (SPP) ¹ Service Discovery Application Profile (SDAP) Dial-Up Networking (DUN) ^{1,2} Generic Object Exchange Profile (GOEP) ^{1,2} Object Push Profile (OPP) ^{1,2} File Transfer Profile (FTP) Synchronization Profile (SYNC) Hard Copy Cable Replacement (HCRP) ^{1,2}	
Certifications	Low Voltage Directive IEC950 UL, CSA, and CE Mark Serial Port Profile (SPP) ¹ Service Discovery Application Profile (SDAP) Dial-Up Networking (DUN) ^{1,2} Generic Object Exchange Profile (GOEP) ^{1,2} Object Push Profile (OPP) ^{1,2} File Transfer Profile (FTP) Synchronization Profile (SYNC) Hard Copy Cable Replacement (HCRP) ^{1,2} Personal Area Networking Profile (PAN) ^{1,2}	
Certifications	Low Voltage Directive IEC950 UL, CSA, and CE Mark Serial Port Profile (SPP) ¹ Service Discovery Application Profile (SDAP) Dial-Up Networking (DUN) ^{1,2} Generic Object Exchange Profile (GOEP) ^{1,2} Object Push Profile (OPP) ^{1,2} File Transfer Profile (FTP) Synchronization Profile (SYNC) Hard Copy Cable Replacement (HCRP) ^{1,2} Personal Area Networking Profile (PAN) ^{1,2} Human Interface Device Profile (HID) ^{1,2}	
Certifications	Low Voltage Directive IEC950 UL, CSA, and CE Mark Serial Port Profile (SPP) ¹ Service Discovery Application Profile (SDAP) Dial-Up Networking (DUN) ^{1,2} Generic Object Exchange Profile (GOEP) ^{1,2} Object Push Profile (OPP) ^{1,2} File Transfer Profile (FTP) Synchronization Profile (SYNC) Hard Copy Cable Replacement (HCRP) ^{1,2} Personal Area Networking Profile (PAN) ^{1,2} Human Interface Device Profile (HID) ^{1,2} FAX Profile (FAX)	
Certifications	Low Voltage Directive IEC950 UL, CSA, and CE Mark Serial Port Profile (SPP) ¹ Service Discovery Application Profile (SDAP) Dial-Up Networking (DUN) ^{1,2} Generic Object Exchange Profile (GOEP) ^{1,2} Object Push Profile (OPP) ^{1,2} File Transfer Profile (FTP) Synchronization Profile (SYNC) Hard Copy Cable Replacement (HCRP) ^{1,2} Personal Area Networking Profile (PAN) ^{1,2} Human Interface Device Profile (HID) ^{1,2} FAX Profile (FAX) Basic Imaging Profile (BIP) ²	
Certifications	Low Voltage Directive IEC950 UL, CSA, and CE Mark Serial Port Profile (SPP) ¹ Service Discovery Application Profile (SDAP) Dial-Up Networking (DUN) ^{1,2} Generic Object Exchange Profile (GOEP) ^{1,2} Object Push Profile (OPP) ^{1,2} File Transfer Profile (FTP) Synchronization Profile (SYNC) Hard Copy Cable Replacement (HCRP) ^{1,2} Personal Area Networking Profile (PAN) ^{1,2} Human Interface Device Profile (HID) ^{1,2} FAX Profile (FAX) Basic Imaging Profile (BIP) ² Headset Profile (HSP)	
Certifications	Low Voltage Directive IEC950 UL, CSA, and CE Mark Serial Port Profile (SPP) ¹ Service Discovery Application Profile (SDAP) Dial-Up Networking (DUN) ^{1,2} Generic Object Exchange Profile (GOEP) ^{1,2} Object Push Profile (OPP) ^{1,2} File Transfer Profile (FTP) Synchronization Profile (SYNC) Hard Copy Cable Replacement (HCRP) ^{1,2} Personal Area Networking Profile (PAN) ^{1,2} Human Interface Device Profile (HID) ^{1,2} FAX Profile (FAX) Basic Imaging Profile (BIP) ²	

Realtek 802.11b/g/n (1x1) Wi-Fi Wireless LAN Standards IEEE 802.11b



	IEEE 802.11g	
	IEEE 802.11n	
Interoperability	Wi-Fi certified	
Frequency Band	802.11b/g/n	
	• 2.402 – 2.482 GHz	
	Note: The FCC has declared as of September 1, 2014 products	
	that utilize passive scanning on channel 12/13 and are	
	capable of transmitting must fully comply with requirements	
Data Rates	of 15.247 or otherwise disable those channels.	
Data Rates	802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps	
	802.11n: MCS 0 ~ MCS 07, (20MHz)	
Modulation	Direct Sequence Spread Spectrum	
	BPSK, QPSK, CCK, 16-QAM, 64-QAM,	
Security ¹	• IEEE and WiFi compliant 64 / 128 bit WEP encryption for	
	a/b/g mode only	
	AES-CCMP: 128 bit in hardware	
	• 802.1x authentication	
	• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.	
	WPA2 certification	
	• IEEE 802.11i	
	Cisco Certified Extensions, all versions through CCX4 and	
	CCX Lite	
	• WAPI	
Network Architecture	Ad-hoc (Peer to Peer)	
Models	Infrastructure (Access Point Required)	
Roaming	IEEE 802.11 compliant roaming between access points	
Output Power ²	• 802.11b : +16dBm minimum	
	• 802.11g : +14dBm minimum	
	• 802.11a : +14dBm minimum	
	• 802.11n HT20(2.4GHz) : +13dBm minimum	
	• 802.11n HT40(2.4GHz) : +13dBm minimum	
	• 802.11n HT20(5GHz) : +12dBm minimum	
	• 802.11n HT40(5GHz) : +12dBm minimum	
Power Consumption	Transmit: 2.0 W (max)	
•	Receive: 1.6 W (max)	
	Idle mode (PSP): 180 mW (WLAN Associated)	
	Idle mode: 60 mW (WLAN unassociated)	
	Radio disabled: 30 mW	
Power Management	ACPI and PCI Express compliant power management	
	802.11 compliant power saving mode	
Receiver Sensitivity ³	802.11b, 1Mbps : -94dBm maximum	
	802.11b, 11Mbps : -86dBm maximum	
	802.11g, 6Mbps : -88dBm maximum	
	802.11g, 54Mbps : -74dBm maximum	



Antenna type	802.11a, 6Mbps : -86dBm maximum 802.11a, 54Mbps : -72dBm maximum 802.11n, MCS07 : -69dBm maximum 802.11n, MCS15 : -66dBm maximum High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded 2.4 GHz antennas are provided to the card to support WLAN and Bluetooth communications (Support Dual antenna or Single antenna, depend on platform requirement)
Form Factor	PCI-Express M.2 MiniCard
Dimensions	Type 2230 : 2.3 x 22.0 x 30.0 mm
	Or
	Type 1630 : 2.3 x 16.0 x 30.0 mm
Weight	Туре 2230 : 2.8g
	Or
	Туре 1630 : 2g
Operating Voltage	3.3v +/- 9%
Temperature	Operating
	Non-operating
Humidity	Operating
	Non-operating
Altitude	Operating
	Non-operating
LED Amber	r – Radio OFF; LED White – Radio ON

** Wireless access point and internet service required. Availability of public wireless access points limited. The specifications for the 802.11ac WLAN are draft specifications and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ac WLAN devices.

Power

HP 4-cell 41Whr	Dimensions (H x W x L)
	Weight
	Cells/Type

20.8mm*38.82mm*274 225g Cylindrical cell 2.8Ah with SDI, LGC , SAN Voltage SDI, SAN: 14.8V; LGC :14.6V Amp-hour capacity SDI,SAN: 2620mAh, LGC :2670mAh Watt-hour capacity SDI,SAN:38.8WH LGC:38.9WH



Temperature	Operating (Charging) Operating (Discharging)	0~45'C -10~60'C
	Non-operating	0~45'C
Battery Re-Charge Time	System in OFF or Standby Mode	
Fuel Gauge LED Warranty	No	
Optional Travel Battery Available	No	

ENVIRONMENTAL HP 240 G5 Notebook PC

Eco-Label Certifications & declarations	 This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks: IT ECO declaration US ENERGY STAR[®] EPEAT < Gold> registered in the United States. See <u>http://www.epeat.net</u> for registration status in your country. 		
System Configuration	The configuration used for the Ene is based on a "Typically Configured		missions data for the Notebook model
Energy Consumption (in accordance with US ENERGY STAR® test method) Normal Operation (Short idle) Normal Operation	115VAC, 60Hz 7.78 W 5.63 W	230VAC, 50Hz 7.66 W 6.38 W	100VAC, 60Hz 8.88 W 5.72 W
(Long idle) Sleep Off	0.55 W 0.32 W	0.63 W 0.37 W	0.56 W 0.29 W

Note:

""

Energy efficiency data listed is for an ENERGY STAR[®] compliant product if offered within the model family. HP computers marked with the ENERGY STAR[®] Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR[®] specifications for computers. If a model family does not offer ENERGY STAR[®] compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows[®] operating system.

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
	Not all configuration cor	nponents are available in all regions/count	ries.

c04934827- DA 15512 - World Wide - Version 5 - July 25, 2016

Technical Specifications

Normal Operation	27 BTU/hr	26 BTU/hr	30 BTU/hr
(Short idle) Normal Operation	19 BTU/hr	22 BTU/hr	20 BTU/hr
(Long idle) Sleep	2 BTU/hr	2 BTU/hr	2 BTU/hr
Off	1 BTU/hr	1 BTU/hr	1 BTU/hr

*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	Sound Power (L _{WAd} , bels)	Sound Pressure (L _{pAm} , decibels)
Typically	2.6	19
Configured –		
Idle		
Fixed Disk –	2.7	20
Random writes		
Longevity and Upgrading	This product can be upgraded, possibly extending its us components contained in the product may include:	eful life by several years. Upgradeable features and/or

- 3 USB ports
- 1 PC card slot (type I/II)
- 1 ExpressCard/54 slot
- 1 IEEE 1394 Port
- 2 SODIMM memory slots
- Optional expansion base docking station
- 1 multi-bay II storage port
- Interchangeable HDD

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

Batteries This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain: Mercury greater the1ppm by weight Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell) Battery type: Lithium



Additional Information	 2011/65/E This HP pro Directive – This product Toxic Enfort This product www.epeat Plastics pation This product 	 2011/65/EC. This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC. This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986). This product is in compliance with the IEEE 1680 (EPEAT) standard at the < gold> level, see www.epeat.net Plastics parts weighing over 25 grams used in the product are marked per IS011469 and IS01043. This product contains 0% post-consumer recycled plastic (by wt.) 	
Packaging Materials	External:	PAPER/Corrugated	325 g
Materials	Internal:	PLASTIC/Polyethylene low density PLASTIC/EPE-Expanded Polyethylene	22 g 100 g
Material Usage	The plastic packaging material contains at least 50% recycled content. The corrugated paper packaging materials contains at least 70% recycled content. Jsage This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):		
	General Specification for the Environment at		o be frequently handled or carried

• Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)



Packaging Usage	 HP follows these guidelines to decrease the environmental impact of product packaging: Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials. Eliminate the use of ozone-depleting substances (ODS) in packaging materials. Design packaging materials for ease of disassembly. Maximize the use of post-consumer recycled content materials in packaging materials. Use readily recyclable packaging materials such as paper and corrugated materials. Reduce size and weight of packages to improve transportation fuel efficiency. Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
End-of-life Management and Recycling	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.
	The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers . These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.
Hewlett- Packard	For more information about HP's commitment to the environment:
Corporate	Global Citizenship Report
Environmental	http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html
Information	Eco-label certifications
	http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates:
	http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC_GBU_Product_Design_ISO_14K_Cert ificate.pdf and
	http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf

HP 250 G5 Notebook PC

Eco-Label Certifications & declarations	 This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks: IT ECO declaration US ENERGY STAR[®] EPEAT <silver> registered in the United States. See http://www.epeat.net for registration status in your country.</silver>
System Configuration Energy Consumption (in accordance	The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".

with US

115VAC, 60Hz

230VAC, 50Hz

100VAC, 60Hz

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Technical Specifications

ENERGY STAR® test method)			
Normal	9.36 W	9.36 W	8.02 W
Operation			
(Short idle)			
Normal	5.29 W	5.00 W	5.64 W
Operation			
(Long idle)			
Sleep	1.08 W	1.19 W	1.07 W
Off	0.31 W	0.41 W	0.30 W

Note:

Energy efficiency data listed is for an ENERGY STAR[®] compliant product if offered within the model family. HP computers marked with the ENERGY STAR[®] Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR[®] specifications for computers. If a model family does not offer ENERGY STAR[®] compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows[®] operating system.

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Normal Operation	32 BTU/hr	32 BTU/hr	27 BTU/hr
(Short idle) Normal Operation	18 BTU/hr	17 BTU/hr	19 BTU/hr
(Long idle) Sleep Off	4 BTU/hr 1 BTU/hr	4 BTU/hr 1 BTU/hr	4 BTU/hr 1 BTU/hr

*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and	Sound Power (L _{WAd} , bels)	Sound Pressure (L _{pAm} , decibels)
ISO 9296) Typically Configured –	3.2	25
ldle Fixed Disk – Random writes	3.3	27

Longevity and Upgrading

and This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

- 3 USB ports
- 1 PC card slot (type I/II)
- 1 ExpressCard/54 slot

• 1 IEEE 1394 Port

• 2 SODIMM memory slots

Optional expansion base docking station



	 1 multi-bay II storage port Interchangeable HDD 					
	Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.					
Batteries	This battery(s) in this product comply with EU Directive 2006/66/EC					
	Mercury great					
Additional Information	 This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC. This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC. This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water an Toxic Enforcement Act of 1986). This product is in compliance with the IEEE 1680 (EPEAT) standard at the <silver> level, see www.epeat.net</silver> Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043. This product contains 0% post-consumer recycled plastic (by wt.) This product is 95.6% recycle-able when properly disposed of at end of life. 			ic Equipment (WEEE) nia; Safe Drinking Water and lver> level, see		
Packaging Materials	External:	PAPER/Corrugated		360.8 g		
riateriats	Internal:	PLASTIC/Polyethylen PLASTIC/EPE-Expand	-	10.6 g 135 g		
The plastic packaging material contains at least 80.9% recycled conten The corrugated paper packaging materials contains at least 75.8% recyMaterial UsageThis product does not contain any of the following substances in excess General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf						
	 Certain Br Cadmium Chlorinate Chlorinate Formalde Halogena Lead carb Lead and Mercuric C Nickel – fit the user. 	ed Hydrocarbons ed Paraffins hyde ted Diphenyl Methanes oonates and sulfates Lead compounds Dxide Batteries	nts – may not be used as flame retardants			



Packaging

Usage

Technical Specifications

- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

HP follows these guidelines to decrease the environmental impact of product packaging:

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- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
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	The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers . These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.					
Hewlett- Packard	For more information about HP's commitment to the environment:					
Corporate	Global Citizenship Report					
Environmental	http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html					
Information	Eco-label certifications					
	http://www8.hp.com/us/en/hp-information/environment/ecolabels.html					
	ISO 14001 certificates:					
	http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC_GBU_Product_Design_ISO_14K_Certifi cate.pdf					
	and					

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf

COUNTRY OF ORIGIN

China



Options and Accessories (Sold separately and availability may vary by country.)

Туре	Description	PartNumber
Cases	HP Essential Top Load Case (up to 15.6")	H2W17AA#xxx
	HP Essential Backpack (up to 15.6")	H1D24AA
	HP Essential Messenger Case (up to 17.3")	H1D25AA
Docking Accessories	HP Universal Port Replicator	E6D70AA#xxx
	HP 3001pr USB 3 Port Replicator	F3S42AA
Input/Output	HP Comfort Grip Wireless Mouse	H2L63AA
	HP USB Essential Keyboard/Mouse	H6L29AA
	HP Slim USB Keyboard and Mouse	T6T83AA
Input-Audio	HP Stereo USB Headset	T1A67AA
UCC	HP Conferencing Keyboard	K8P74AA#xxx
	HP Speaker Phone	K7V16AA
	HP Wired Headset	K7V17AA
Adapters	HP 45W Smart AC Adapter (4.5mm)	H6Y88AA#xxx
	HP 65W Smart AC Adapter (4.5mm)	H6Y89AA#xxx
	HP 65W Slim AC Adapter	H6Y82AA#xxx
	HP 7.4mm to 4.5mm DC Dongle	K0Q39AA
Power Bank	HP Notebook Power Bank	N9F71AA#xxx
Security	HP Essential Combination Lock	T0Y16AA
Display	HP ProDisplay P240va	N3H14A
	HP V272	M4B78A



Summary of Changes

Date of change:	Version History:		Description of change:
February 22, 2016	Version 1 to 2	Changed	Several edits throughout the document
March 30, 2016	Version 2 to 3	Removed	Removed TLC from 256 GB SATA-3
April 25, 2016	Version 3 to 4	Added	Battery life for 250
July 25, 2016	Verstion 4 to 5	Added	Environmental info

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